

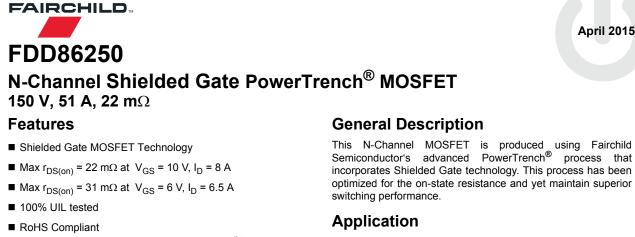
Is Now Part of



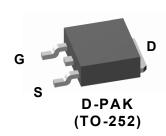
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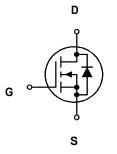
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DC - DC Conversion





MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			150	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T _C = 25 °C	(Note 5)	51		
	-Continuous	T _C = 100 °C	(Note 5)	27	•	
	-Continuous	T _A = 25 °C	(Note 1a)	8	Α	
	-Pulsed		(Note 4)	164		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	180	mJ	
P _D	Power Dissipation $T_{\rm C} = 25$ °C			132	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	3.1	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case		0.94	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	C/vv

Package Marking and Ordering Information

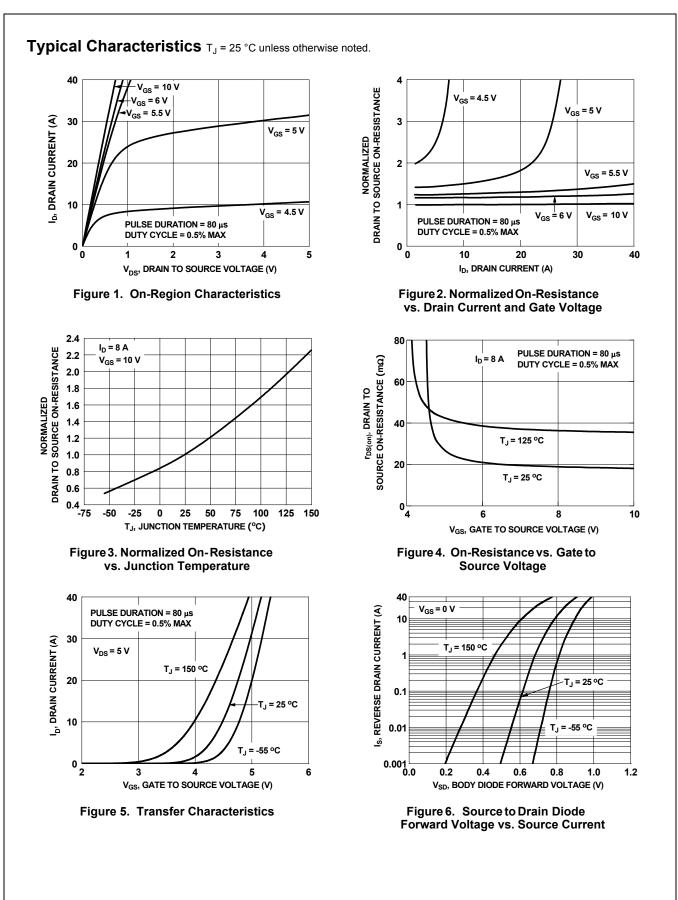
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86250	FDD86250	D-PAK(TO-252)	13 "	16 mm	2500 units

April 2015

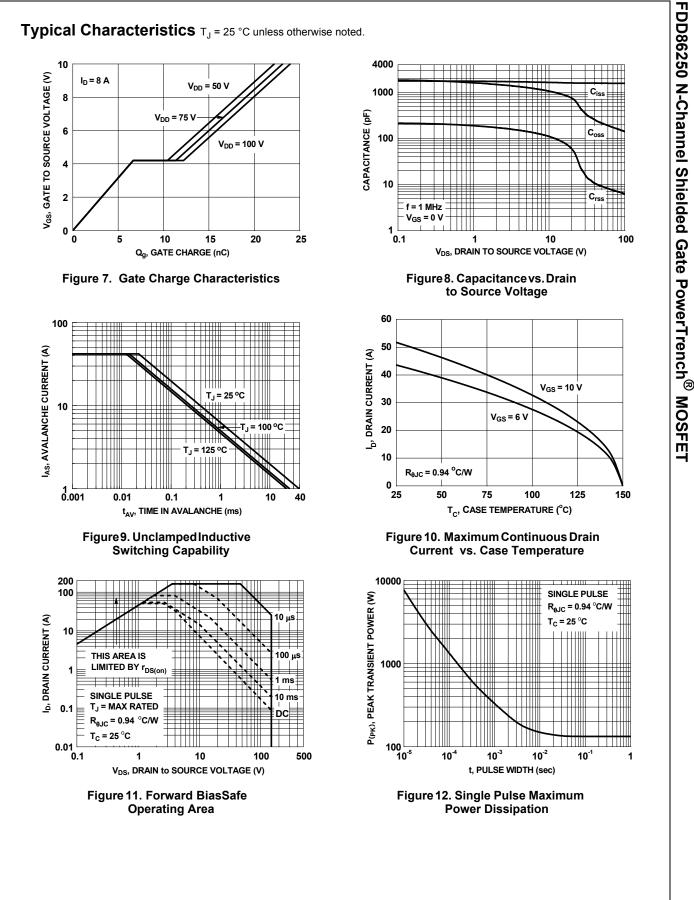
	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	cteristics			1	L.	
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150	1		V
ABV _{DSS}	Breakdown Voltage Temperature		100	106		
ΔT_{J}	Coefficient	I_D = 250 μ A, referenced to 25 °C		106		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 120 V, V_{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	2.9	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C		-10		mV/°C
		V _{GS} = 10 V, I _D = 8 A		18.4	22	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 6 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$		21.4	31	mΩ
		V _{GS} = 10 V, I _D = 8 A, T _J = 125 °C		35.8	45	1
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 8 A		28		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			1585	2110	pF
C _{oss}	Output Capacitance	$V_{DS} = 75 V, V_{GS} = 0 V,$		167	225	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		7	15	pF
R _g	Gate Resistance			0.6		Ω
-	g Characteristics			L		1
t _{d(on)}	Turn-On Delay Time			11.2	20	ns
t _r	Rise Time	V _{DD} = 75 V, I _D = 8 A,		3.7	10	ns
d(off)	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		20	32	ns
t _f	Fall Time			4	10	ns
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		23	33	nC
Qg	Total Gate Charge	V_{GS} = 0 V to 5 V V_{DD} = 75 V,		12.8	18	nC
Q _{gs}	Gate to Source Charge	I _D = 8 A		6.7		nC
	Gate to Drain "Miller" Charge			4.7		nC
Q _{gd}						
	urce Diode Characteristics					
Drain-Soເ		V _{GS} = 0 V, I _S = 8 A (Note 2)		0.78	1.3	V
Drain-Soເ	Source-Drain Diode Forward Voltage	$\frac{V_{GS} = 0 \text{ V}, \text{ I}_{S} = 8 \text{ A}}{V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2.6 \text{ A}} (\text{Note 2})$		0.78 0.73	1.3 1.2	V
						V ns

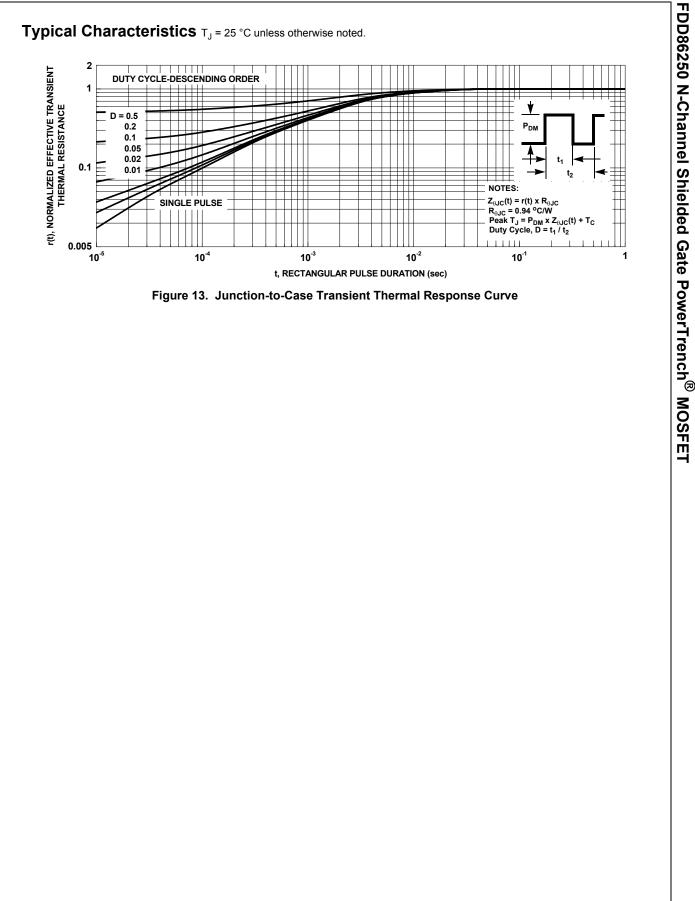
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Pulse Test: Pulse Width < 300 µs, Duty cycle < 2.0%.
Starting T_J = 25 °C, L = 1.0 mH, I_{AS} = 19 A, V_{DD} = 135 V, V_{GS} = 10 V.
Pulsed Id please refer to Fig 11 SOA graph for more details.
Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.



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